

L Number	Hits	Search Text	DB	Time stamp
1	461	137/112.ccls.	USPAT; US-PGPUB	2004/04/19 14:05
2	265	137/113.ccls.	USPAT; US-PGPUB	2004/04/19 14:05
3	636	222/148.ccls.	USPAT; US-PGPUB	2004/04/19 14:05
4	184	222/152.ccls.	USPAT; US-PGPUB	2004/04/19 14:05
-	0	chmeical adj delivery same (semiconductor adj fabrication and process adj tool)	USPAT; US-PGPUB	2004/04/19 11:21
-	5	chemical adj delivery same (semiconductor adj fabrication and process adj tool)	USPAT; US-PGPUB	2004/04/19 11:21
-	1	6264064.URPN.	USPAT	2004/04/19 11:26
-	1	6264064.URPN.	USPAT	2004/04/19 11:26
-	14	("3100885" "4053085" "4440319" "4580448" "4770038" "4949878" "5199603" "5303585" "5562132" "5663503" "6077356" "6202484" "6264064" "6397656" "2002/0108670").PN.	USPAT	2004/04/19 11:26
-	14	("3100885" "4053085" "4440319" "4580448" "4770038" "4949878" "5199603" "5303585" "5562132" "5663503" "6077356" "6202484" "6264064" "6397656" "2002/0108670").PN.	USPAT	2004/04/19 11:26
-	1	6264064.URPN.	USPAT	2004/04/19 11:27
-	1	6264064.URPN.	USPAT	2004/04/19 11:27
-	2	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 141/302.ccls.	USPAT; US-PGPUB	2004/04/19 11:29
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 141/1.ccls.	USPAT; US-PGPUB	2004/04/19 11:29
-	1	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 141/47.ccls.	USPAT; US-PGPUB	2004/04/19 11:30
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 141/49.ccls.	USPAT; US-PGPUB	2004/04/19 11:30
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 141/104.ccls.	USPAT; US-PGPUB	2004/04/19 11:30
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 134/16C.ccls.	USPAT; US-PGPUB	2004/04/19 11:30
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 134/166C.ccls.	USPAT; US-PGPUB	2004/04/19 11:42
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 134/1.3.ccls.	USPAT; US-PGPUB	2004/04/19 11:31

-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 134/1.2.ccls.	USPAT; US-PGPUB	2004/04/19 11:41
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 134/22.14.ccls.	USPAT; US-PGPUB	2004/04/19 11:41
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 134/22.19.ccls.	USPAT; US-PGPUB	2004/04/19 11:41
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 134/94.1.ccls.	USPAT; US-PGPUB	2004/04/19 11:41
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 134/95.1.ccls.	USPAT; US-PGPUB	2004/04/19 11:41
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 134/98.1.ccls.	USPAT; US-PGPUB	2004/04/19 11:41
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 134/99.2.ccls.	USPAT; US-PGPUB	2004/04/19 11:42
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 134/102.2.ccls.	USPAT; US-PGPUB	2004/04/19 11:42
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 134/171.ccls.	USPAT; US-PGPUB	2004/04/19 11:42
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 137/15.04.ccls.	USPAT; US-PGPUB	2004/04/19 11:43
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 137/15.05.ccls.	USPAT; US-PGPUB	2004/04/19 11:43
-	1	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 137/209.ccls.	USPAT; US-PGPUB	2004/04/19 11:43
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 137/240.ccls.	USPAT; US-PGPUB	2004/04/19 11:44
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 137/883.ccls.	USPAT; US-PGPUB	2004/04/19 11:44
-	0	(chemical adj delivery same (semiconductor adj fabrication and process adj tool)) and 137/885.ccls.	USPAT; US-PGPUB	2004/04/19 11:44
-	498352	"6199599" B1	USPAT; US-PGPUB	2004/04/19 11:47
-	3	"6199599"	USPAT; US-PGPUB	2004/04/19 11:47
-	1	6457494.URPN.	USPAT	2004/04/19 11:47
-	1	6457494.URPN.	USPAT	2004/04/19 11:47

	43	("2160062" "2536273" "2777914" "3034543" "3081905" "3419695" "3646293" "3653549" "3731805" "3930591" "4056979" "4064755" "4134514" "4298037" "4425949" "4436674" "4576552" "4676404" "4730491" "4859375" "4976146" "4979545" "4979643" "5038840" "5041267" "5069244" "5079950" "5090212" "5103673" "5137063" "5148945" "5279338" "5285812" "5329963" "5465766" "5479959" "5551309" "5562132" "5590695" "5607002" "5628342" "5711354" "5878793").PN.	USPAT	2004/04/19 11:48
	43	("2160062" "2536273" "2777914" "3034543" "3081905" "3419695" "3646293" "3653549" "3731805" "3930591" "4056979" "4064755" "4134514" "4298037" "4425949" "4436674" "4576552" "4676404" "4730491" "4859375" "4976146" "4979545" "4979643" "5038840" "5041267" "5069244" "5079950" "5090212" "5103673" "5137063" "5148945" "5279338" "5285812" "5329963" "5465766" "5479959" "5551309" "5562132" "5590695" "5607002" "5628342" "5711354" "5878793").PN.	USPAT	2004/04/19 11:48